505644001 08/28/2019

EPAS ID: PAT5690807

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BRANDON P. WIRZ	08/28/2019
BRADLEY B. BITZ	08/28/2019
PEI SIAN SHAO	08/28/2019

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
Internal Address:	MAILSTOP 1-507
City:	BOISE
State/Country:	IDAHO
Postal Code:	83707-0006

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16553504

CORRESPONDENCE DATA

Fax Number: (801)531-9168

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 801-532-1922

Email: djpfeil@traskbritt.com

TRASK BRITT, P.C./ MICRON TECHNOLOGY **Correspondent Name:**

Address Line 1: P.O. BOX 2550

Address Line 4: SALT LAKE CITY, UTAH 84110

ATTORNEY DOCKET NUMBER:	2269-15042(2019-0587.00)	
NAME OF SUBMITTER:	JOSEPH A. WALKOWSKI	
SIGNATURE:	/Joseph A. Walkowski/	
DATE SIGNED:	08/28/2019	

Total Attachments: 4

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Attorney Docket No. 2269-P15042US (2019-0587.00/US)

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, each undersigned ASSIGNOR does hereby:

SELL, ASSIGN AND TRANSFER to MICRON TECHNOLOGY, INC.

("ASSIGNEE"), a corporation of the State of Delaware, having a place of business at 8000 South Federal Way, Mailstop 1-507, Boise, ID 83707-0006, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements that are disclosed in the Application for United States Letters Patent that has been executed by each undersigned ASSIGNOR concurrently herewith, and titled METHODS AND APPARATUS FOR INTEGRATED GANG BONDING AND ENCAPSULATION OF STACKED MICROFLECTRONIC DEVICES, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent or the legal equivalent thereof that have been or may be filed in the United States and all foreign countries relating to any of such improvements; all original, reexamined and reissued patents that have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application made in the United States;

AUTHORIZE the ASSIGNEE to apply for and receive any and all United States and foreign patents relating to such improvements in its own name;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to and in the name of the ASSIGNEE;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement or encumbrance affecting the rights and property herein conveyed has been or will be made or entered into by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, to execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications relating to any and all such improvements; to execute all rightful oaths, declarations, assignments, powers of attorney and other papers; to communicate to the ASSIGNEE all facts and provide to the ASSIGNEE all documents and things known and accessible to the undersigned relating to such improvements and the history thereof, and testify as to the same in any interference, litigation or other proceeding relating thereto; and generally to do everything possible that the ASSIGNEE shall consider desirable for vesting title to such improvements in the ASSIGNEE, and to secure, maintain, defend and enforce valid and enforceable patent protection for such improvements;

AGREE AND ACKNOWLEDGE that the SALE, ASSIGNMENT AND TRANSFER of rights and property set forth herein is and shall be IRREVOCABLE and BINDING upon the heirs, assigns, representatives and successors of each undersigned ASSIGNOR and EXTEND to the successors, assigns and nominees of the ASSIGNEE.

ASSIGNOR(S):	
Brandon & Wis	Date: 8/28/2019
Brandon P. Wirz Residing at: 6045 South Sweet Gum Way, Boise, ID 837	
Witness:	
Signature	Date:
Printed Name:	ú.
Address:	•••
Witness:	
Signature:	Date:
Printed Name:	4
Address:	
	<u></u>

Bradley K. Bitz Residing at: 7955 W. War Bonnet, Boise, ID 83709	Date: <u>829/19</u>
Witness: Signature: Printed Name: Address:	Date:
Witness: Signature: Printed Name: Address:	Date:

Pei Sian Shao	Date: 8/28/2019
Pei Sian Shao	
Residing at: No. 38, Sec. 1, Houxing Rd., Zhongli Dist., T	aoyuan City 320 Taiwan
Witness:	
Signature:	Parton
Signature:	Date:
Printed Name:	
Address:	
	•
Witness:	
Clamatican	D-4
Signature:	Date:
Printed Name:	
Address:	

RECORDED: 08/28/2019